

PHASE CONTROL THYRISTOR

AT202

Repetitive voltage up to **800 V**
 Mean on-state current **635 A**
 Surge current **6 kA**

TARGET SPECIFICATION

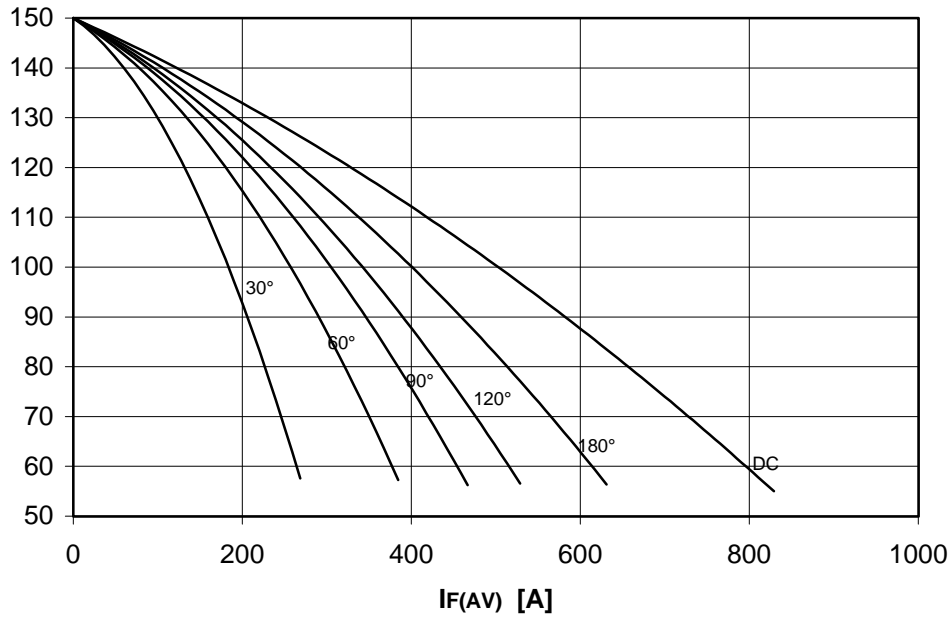
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Symbol	Characteristic	Conditions	T _j [°C]	Value	Unit
BLOCKING					
V _{RRM}	Repetitive peak reverse voltage		150	800	V
V _{RSM}	Non-repetitive peak reverse voltage		150	900	V
V _{DRM}	Repetitive peak off-state voltage		150	800	V
I _{RRM}	Repetitive peak reverse current	V=V _{RRM}	150	30	mA
I _{DRM}	Repetitive peak off-state current	V=V _{DRM}	150	30	mA
CONDUCTING					
I _{T(AV)}	Mean on-state current	180° sin, 50 Hz, Th=55°C, double side cooled		635	A
I _{T(AV)}	Mean on-state current	180° sin, 50 Hz, Tc=85°C, double side cooled		575	A
I _{TSM}	Surge on-state current	sine wave, 10 ms	150	6	kA
I ² t	I ² t	without reverse voltage		180 x1E3	A ² s
V _T	On-state voltage	On-state current = 800 A	150	1.19	V
V _{T(TO)}	Threshold voltage		150	0.8	V
r _T	On-state slope resistance		150	0.490	mohm
SWITCHING					
di/dt	Critical rate of rise of on-state current, min.	From 75% V _{DRM} up to 450 A, gate 10V 5ohm	150	320	A/μs
dv/dt	Critical rate of rise of off-state voltage, min.	Linear ramp up to 70% of V _{DRM}	150	500	V/μs
t _d	Gate controlled delay time, typical	V _D =100V, gate source 10V, 10 ohm, tr=.5 μs	25	1.6	μs
t _q	Circuit commutated turn-off time, typical	dV/dt = 20 V/μs linear up to 75% V _{DRM}		200	μs
Q _{rr}	Reverse recovery charge	di/dt=-20 A/μs, I= 290 A	150		μC
I _{rr}	Peak reverse recovery current	VR= 50 V			A
I _H	Holding current, typical	V _D =5V, gate open circuit	25	300	mA
I _L	Latching current, typical	V _D =5V, tp=30μs	25	700	mA
GATE					
V _{GT}	Gate trigger voltage	V _D =5V	25	3.5	V
I _{GT}	Gate trigger current	V _D =5V	25	200	mA
V _{GD}	Non-trigger gate voltage, min.	V _D =V _{DRM}	150	0.25	V
V _{FGM}	Peak gate voltage (forward)			20	V
I _{FGM}	Peak gate current			8	A
V _{RGM}	Peak gate voltage (reverse)			5	V
P _{GM}	Peak gate power dissipation	Pulse width 100 μs		75	W
P _G	Average gate power dissipation			1	W
MOUNTING					
R _{th(j-h)}	Thermal impedance, DC	Junction to heatsink, double side cooled		95	°C/kW
R _{th(c-h)}	Thermal impedance	Case to heatsink, double side cooled		20	°C/kW
T _j	Operating junction temperature			-30 / 150	°C
F	Mounting force			4.9 / 5.9	kN
	Mass			55	g
ORDERING INFORMATION : AT202 S 08					
standard specification <input type="checkbox"/> VDRM&VRRM/100 <input type="checkbox"/>					

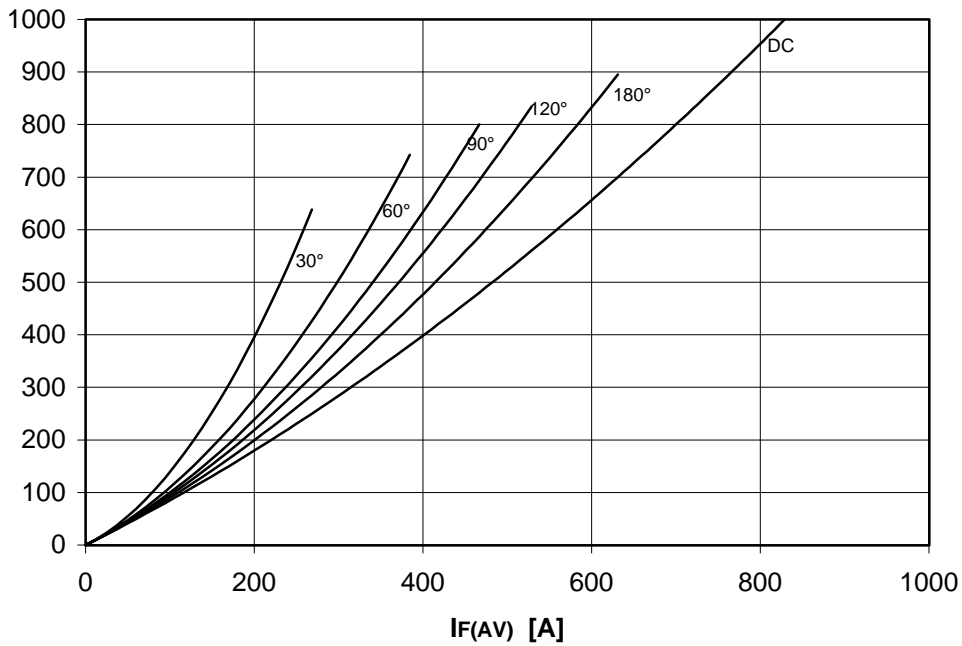
DISSIPATION CHARACTERISTICS

SQUARE WAVE

Th [°C]



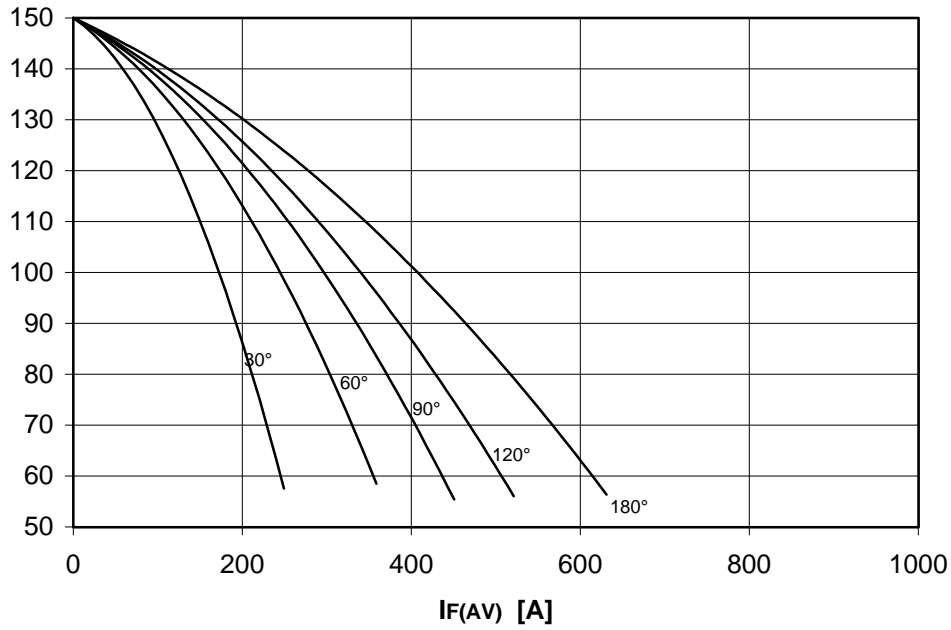
PF(AV) [W]



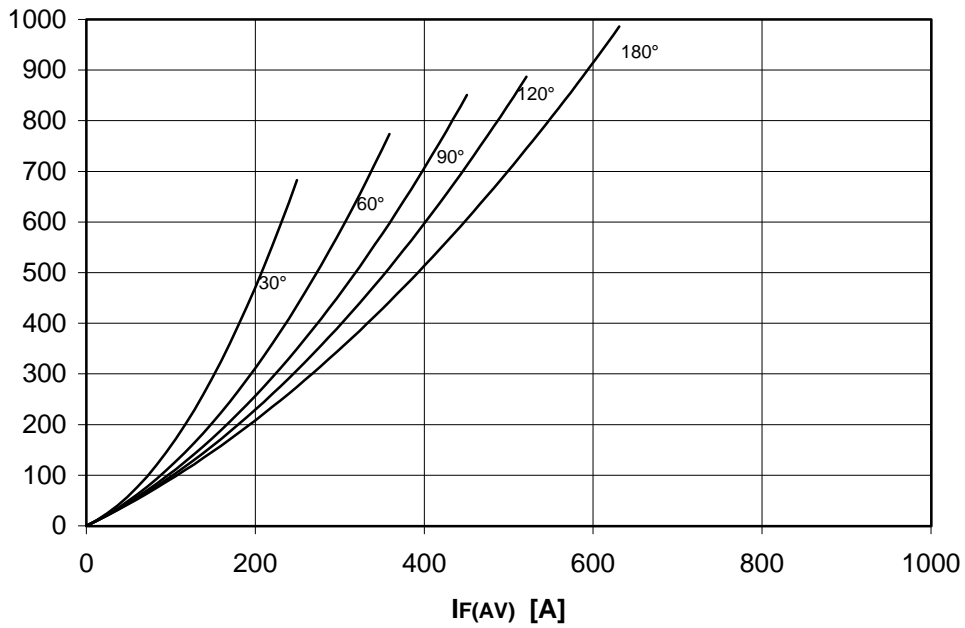
DISSIPATION CHARACTERISTICS

SINE WAVE

Th [°C]

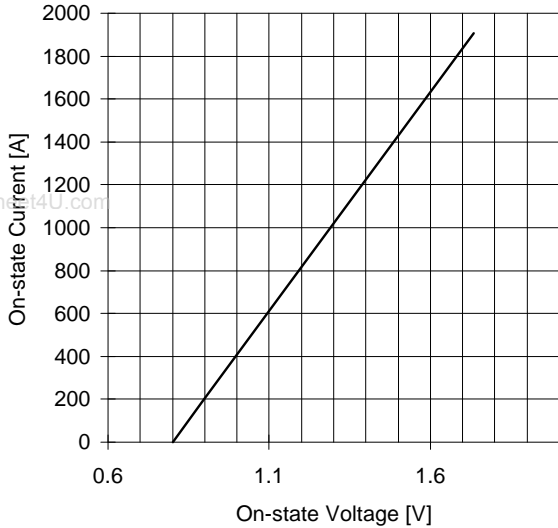


PF(AV) [W]

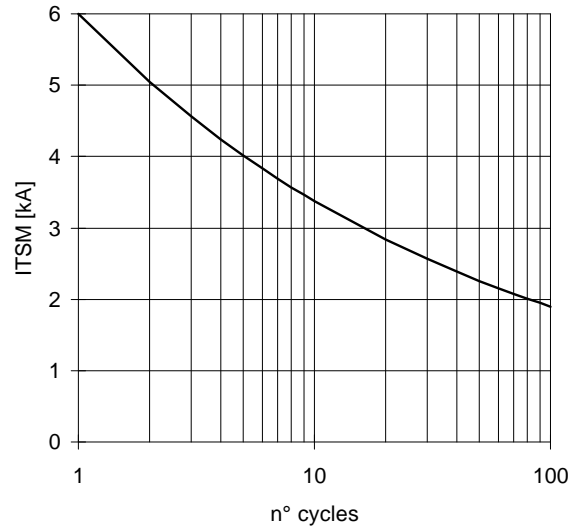


TARGET SPECIFICATION Feb 97 - ISSUE : 03

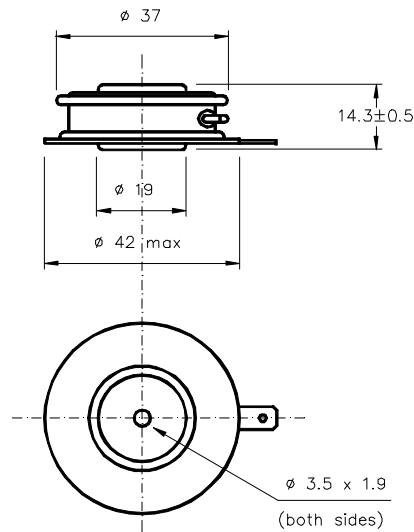
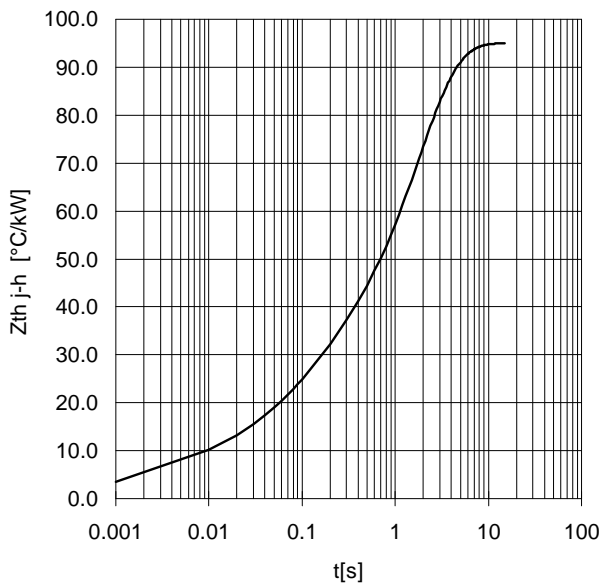
ON-STATE CHARACTERISTIC
T_j = 150 °C



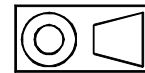
SURGE CHARACTERISTIC
T_j = 150 °C



TRANSIENT THERMAL IMPEDANCE
DOUBLE SIDE COOLED



Dimensions
in mm



Cathode terminal type DIN 46244 - A 4.8 - 0.8

Gate terminal type AMP 60598 - 1

All the characteristics given in this data sheet are guaranteed only with uniform clamping force, cleaned and lubricated heatsink, surfaces with flatness < .03 mm and roughness < 2 μ m.

In the interest of product improvement ANSALDO reserves the right to change any data given in this data sheet at any time without previous notice.

If not stated otherwise the maximum value of ratings (symbols over shaded background) and characteristics is reported.

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